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带有集成 DST80 认证、EEPROM 和 LF 发动机防盗系统的数字签名应答机

查询样品: TMS37145

特性

- 低频 (LF) 发动机防盗系统接口
 - 75 字节 EEPROM
 - 80 位 DST80 安全认证协处理器
 - 集成无电池发动机防盗系统接口
 - 半双工 (HDX) 发动机防盗系统通信实现高达 4 英寸 (10cm) 读取范围
 - 特别选择寻址模式支持可靠学习实践队列
 - 80 位认证密钥长度
 - 高达每秒 8k 位上行数据速率
 - 5/3 字节质询/应答算法
 - 42ms 内的快速认证

- 65ms 内的快速相互认证
- 75 字节 EEPROM
 - 48 字节可用 EEPROM 用户内存
 - 32 位唯一串号
 - 高 EEPROM 安全性和灵活性
 - 只写入认证密钥
 - 页是不可逆可锁定的和可保护的
 - 只通过相互认证,才可对受保护的页编程
- 每个用户页是可锁定的
- 谐振频率: 134.2kHz

描述

这个全新一代安全 RFID 应答机,此应答机借助其集成的 80 位加密算法提供最高的安全级别。 5 字节质询和 3 字节应答算法与现有的 TI 产品向后兼容,并且与突发长度编码一起,提供较短加密电报时间。

DST80 提供 65 字节的空闲可编程用户数据,这些数据存储于九个页内,其中的每个页可针对编程进行锁定。 两个 80 位加密密钥的每一个密钥可使用一个单一电报进行编程。

DST80 有两个版本,使用脉宽调制 (PWM) 或者脉冲位置调制 (PPM) 通信格式进行预编程,这样用户就不必改变这个字段。

订购信息(1)

T _A	封装(2)	通信格式	可订购部件号		
-40°C 至 85°C	±	PWM	TMS37145TEAIE		
	中插	PPM	TMS37145TEAIEG		

- (1) 要获得最新的封装和订货信息,请参阅本文档末尾的封装选项附录,或者登录 TI 的网站 www.ti.com进行查询。
- (2) 封装图样、热数据和符号可登录 www.ti.com/packaging获取。





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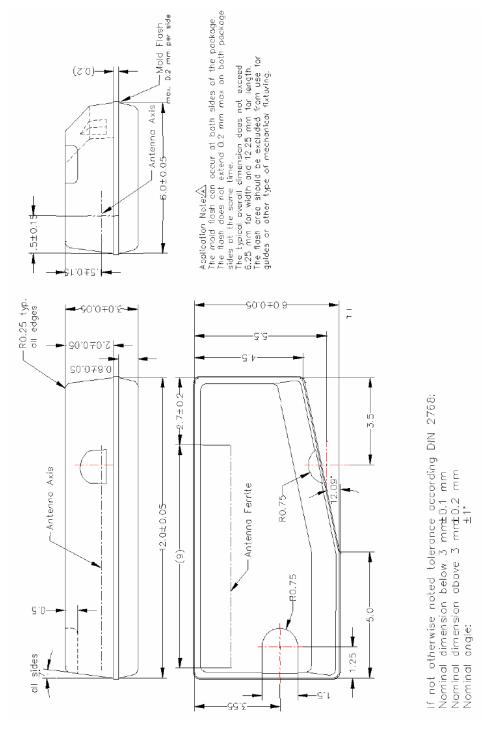
Operating Characteristics

Part Number	TMS37145TEAIE, TMS37145TEAIEG					
Features	Immobilizer plus microcontroller with integrated power management					
DST80 authentication logic	80-bit key length, 4-byte or 5-byte challenge, 3-byte signature					
DST80 encryption time	Mutual authentication: 65 ms Fast authentication: 42 ms					
Transponder						
Transmission principle	HDX (half duplex telegram protocol)					
Operating frequency	134.2 kHz Integrated resonant frequency trimming capability via LF or test interface					
Security	Challenge/response, mutual authentication					
Downlink	100% AM, PPM bit coding with 2 kbit/s (typ)					
Uplink	FSK modulation with 7.9 kbit/s (typ)					
Read time for an encryption	PPM: 60 ms (typ) (including 20-ms charge time)					
Read time for mutual authentication	PPM: 85 ms (typ) (including 20-ms charge time)					
Protocol transmission security	16-bit block check character					
Activation field strength	141.5 dBμA/m					
Minimum required operation Q-factor	30					
		48-byte free available EEPROM user memory				
EEPROM memory	75 bytes	32-bit unique serial number				
		Two 80-bit security keys				
EEPROM endurance	200 000 (min) write-erase cycles (T _A = 25°C)					
Key learn-in	Special selective addressing to provide secure learn-in procedure					
Storage temperature	-40°C to 100°C	(175°C for 5 minutes)				
Operating temperature	-40°C to 85°C					
Case material	Plastic					
Protection class	IP 68					
EMC	Programmed code is not affected by natural electromagnetic interference or X-rays					
Mechanical shock	IEC 68-2-27, Test Ea; 200 g, half sine, 3 ms, 6 shocks per axis					
Vibration	IEC 68-2-6, Test Fc; 10 to 500 Hz, 1.65 mm peak to peak, 10 g, 4 hours per axis					
Dimensions	12.0 mm ± 0.2 mm x 6.0 mm ± 0.2 mm x 3.0 mm ± 0.05 mm					
Weight	0.4 g					
Packaging	Bulk (2000 units per box)					



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MECHANICAL DATA



www.ti.com 20-Apr-2022

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
TMS37145TEAIE	ACTIVE	RFIDP	TEA	0	2000	RoHS & Green	Call TI	Level-1-260C-UNLIM	-40 to 85		Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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